

MLD GROUP

INDUSTRIAL & POWER CONVERSION DIVISION

Off-line SMPS BU Application Lab

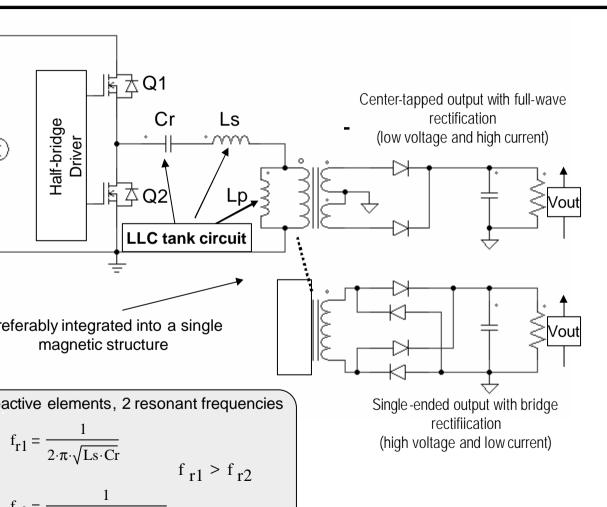
Application & Architecture Manager, System & Application Expert

Presentation Outline

- LLC series-resonant Half-bridge: operation and significant waveforms
- Simplified model (FHA approach)
- 300W design example



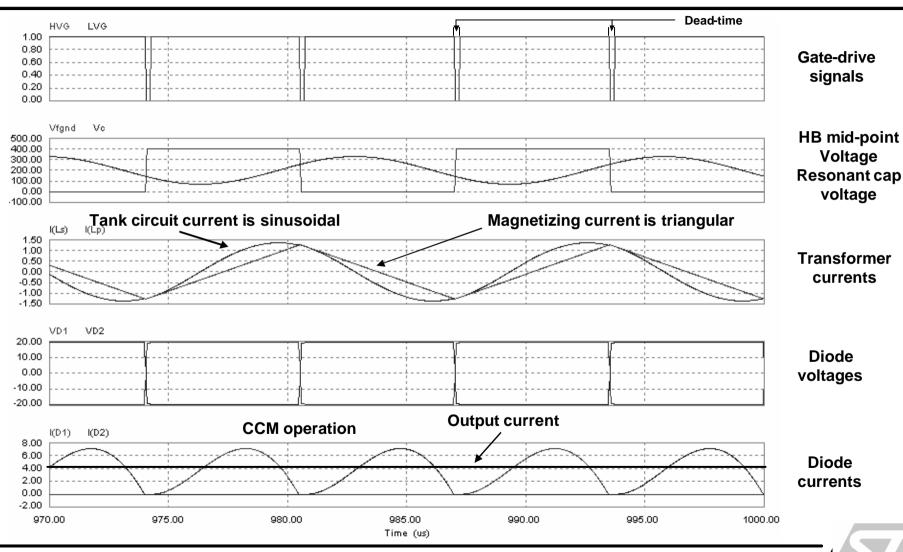
eries-resonant LLC Half-Bridge opology and features



- Multi-resonant LLC tank circu
- Variable frequency control
- Fixed 50% duty cycle for Q1 8
- Dead-time between LG and HG allow MOSFET's ZVS @ turn-G
- fsw ≈ fr, sinusoidal waveforms turn-off losses, low EMI
- Equal voltage & current stress secondary rectifiers; ZCS, the recovery losses
- No output choke; cost saving
- Integrated magnetics: both L' be realized with the transform
- High efficiency: >96% achieva

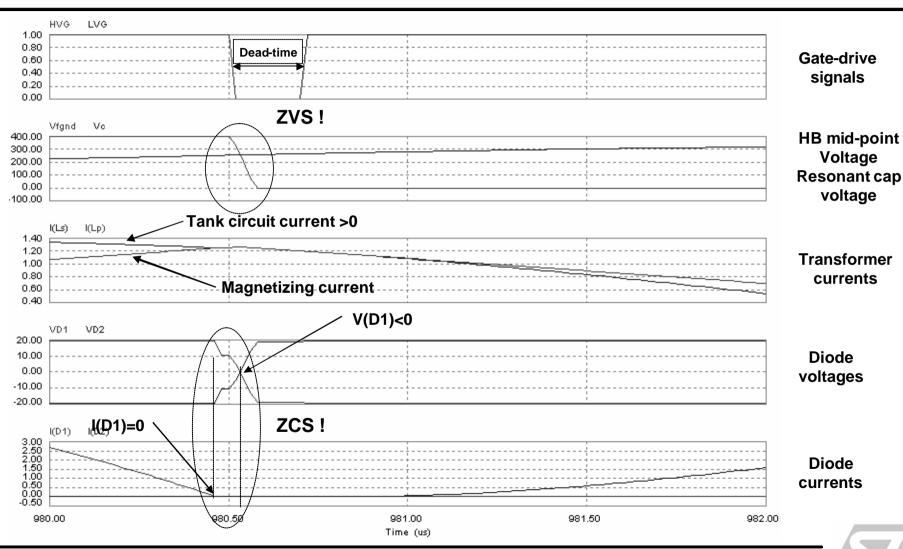


LC Resonant Half-bridge vaveforms at resonance $(f_{sw} = f_{r1})$



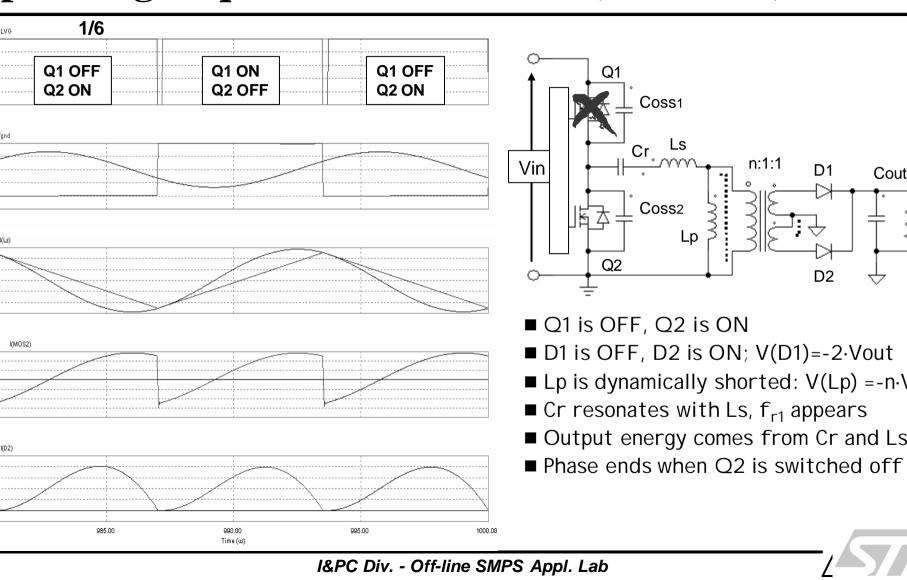
I&PC Div. - Off-line SMPS Appl. Lab

LC Resonant Half-bridge witching details at resonance $(f_{sw} = f_{r1})$

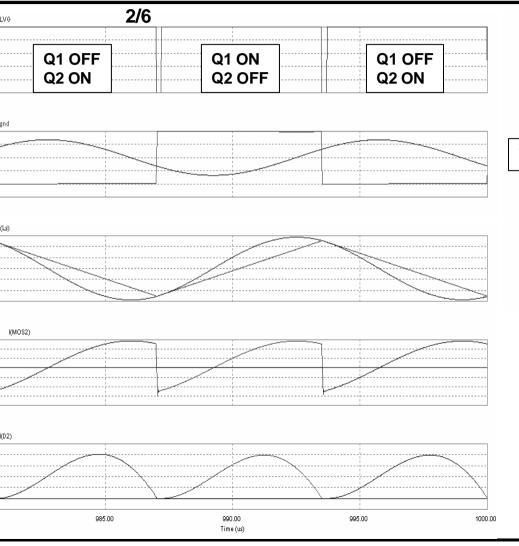


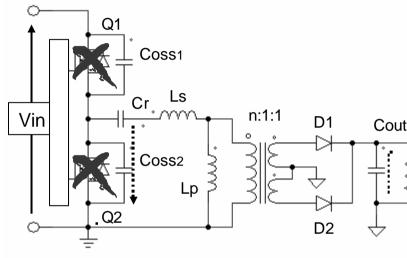
I&PC Div. - Off-line SMPS Appl. Lab

LC Resonant Half-bridge perating Sequence at resonance (Phase 1/6)



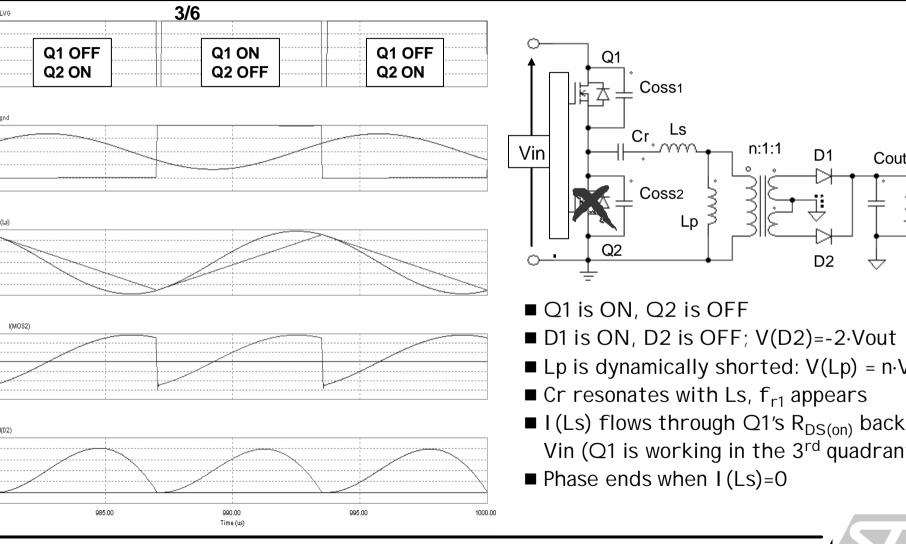
LC Resonant Half-bridge perating Sequence at resonance (Phase 2/6)





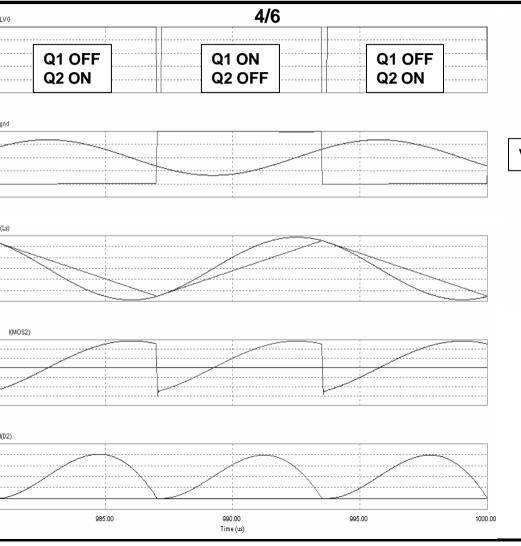
- Q1 and Q2 are OFF (dead-time)
- D1 and D2 are OFF; V(D1)=V(D2)=0; transformer's secondary is open
- I (Ls+Lp) charges C_{OSS2} and discharge C_{OSS1}, until V(C_{OSS2})=Vin; Q1's body of starts conducting, energy goes back
- I (D2) is exactly zero at Q2 switch o
- Phase ends when Q1 is switched on

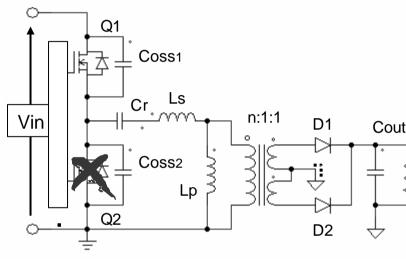
LC Resonant Half-bridge perating Sequence at resonance (Phase 3/6)



Cout

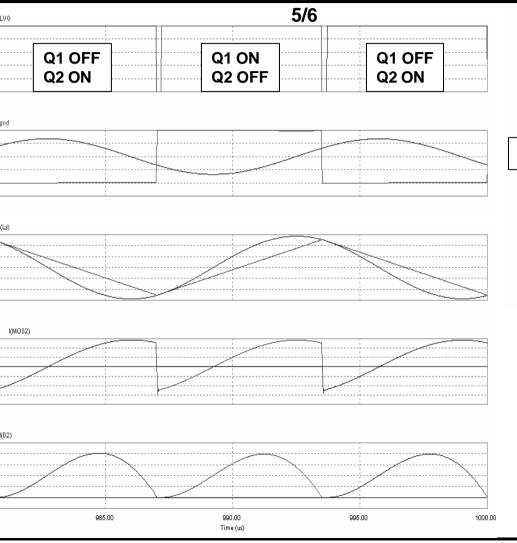
LC Resonant Half-bridge perating Sequence at resonance (Phase 4/6)

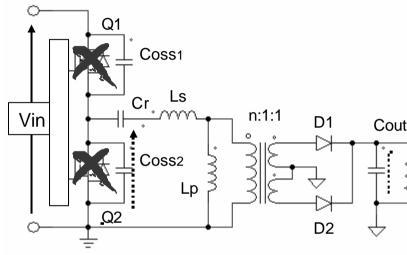




- Q1 is ON, Q2 is OFF
- D1 is ON, D2 is OFF; V(D2)=-2·Vout
- Lp is dynamically shorted: $V(Lp) = n \cdot V$
- Cr resonates with Ls, f_{r1} appears
- I(Ls) flows through Q1's R_{DS(on)} from to ground
- Energy is taken from Vin and goes to
- Phase ends when Q1 is switched off

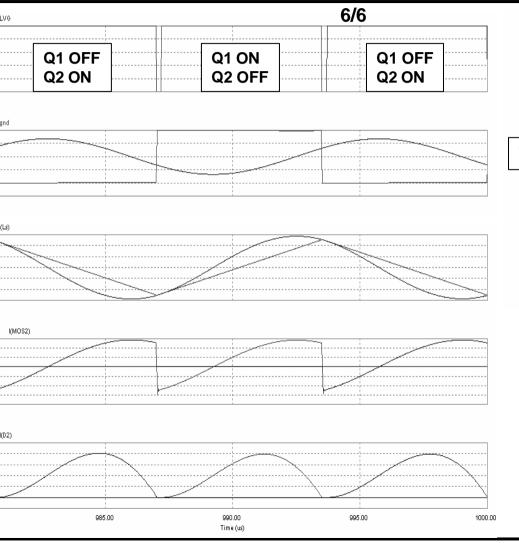
LC Resonant Half-bridge perating Sequence at resonance (Phase 5/6)

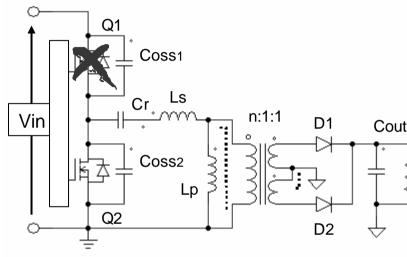




- Q1 and Q2 are OFF (dead-time)
- D1 and D2 are OFF; V(D1)=VD(2)=0; transformer's secondary is open
- I (Ls+Lp) charges C_{OSS1} and discharge C_{OSS2}, until V(C_{OSS2})=0; Q2's body die starts conducting
- I (D1) is exactly zero at Q1 switch of
- Phase ends when Q2 is switched on

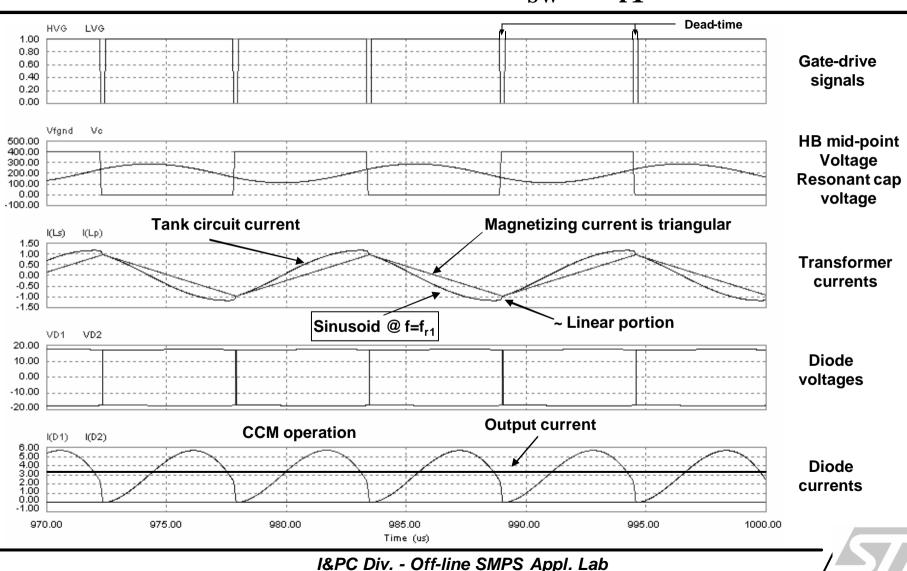
LC Resonant Half-bridge perating Sequence at resonance (Phase 6/6)



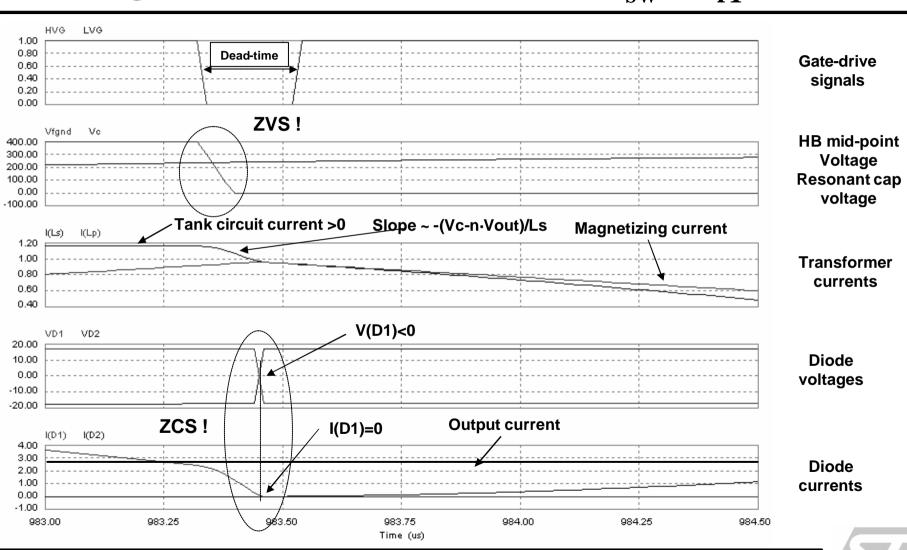


- Q1 is OFF, Q2 is ON
- D1 is OFF, D2 is ON
- Lp is dynamically shorted: V(Lp) =-n·\
- Cr resonates with Ls, fr1 appears
- I(Ls) flows through Q2's R_{DS(on)} (Q2 working in the 3rd quadrant)
- Output energy comes from Cr and Ls
- Phase ends when I (Ls)=0, Phase 1 sta

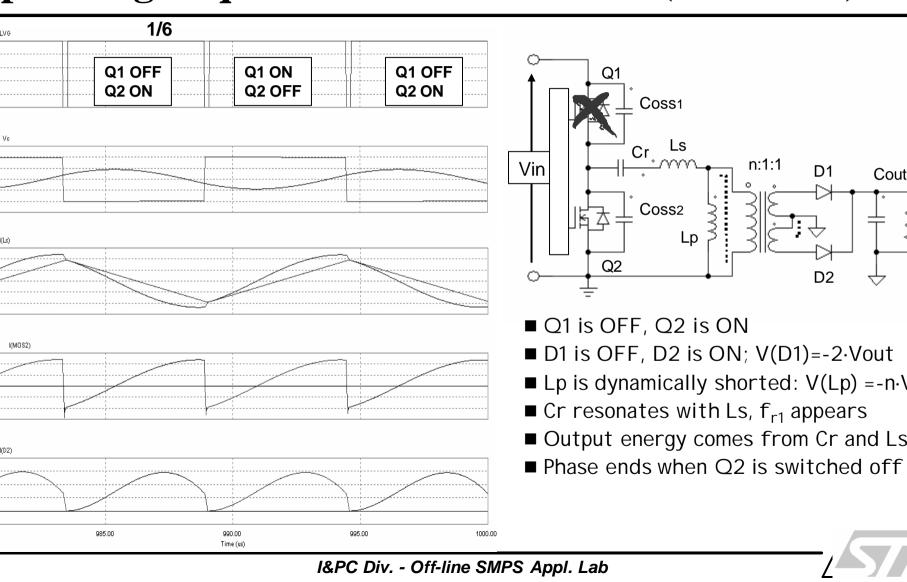
LC Resonant Half-bridge vaveforms above resonance (f_{sw} > f_{r1})



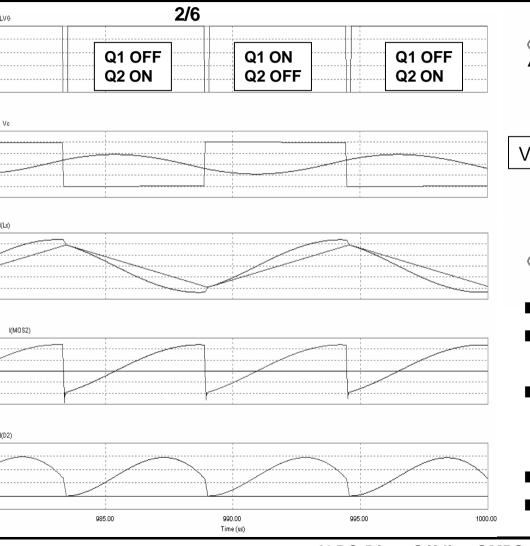
LC Resonant Half-bridge witching details above resonance (f_{sw} > f_{r1})

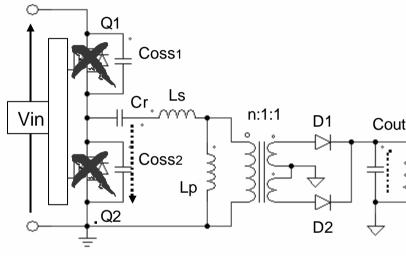


LC Resonant Half-bridge perating Sequence above resonance (Phase 1/6)



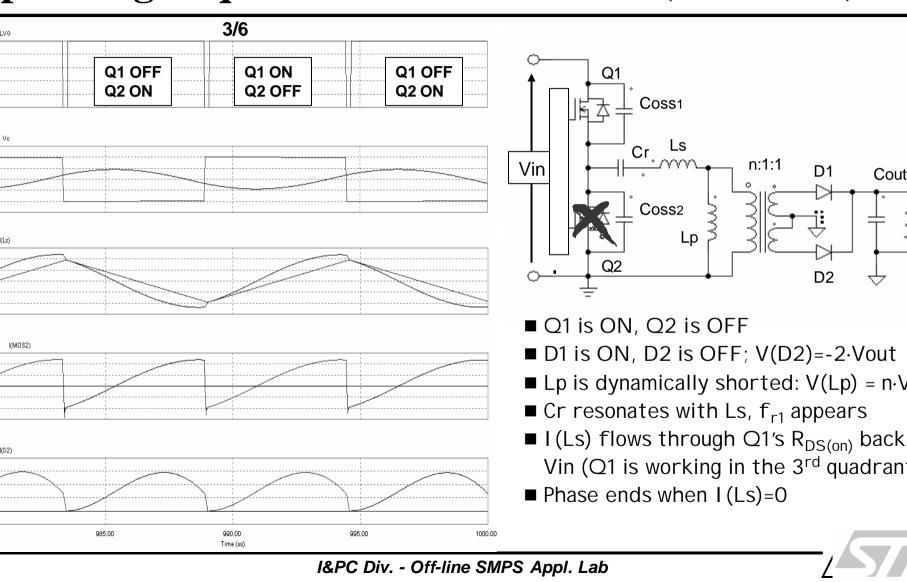
LC Resonant Half-bridge perating Sequence above resonance (Phase 2/6)



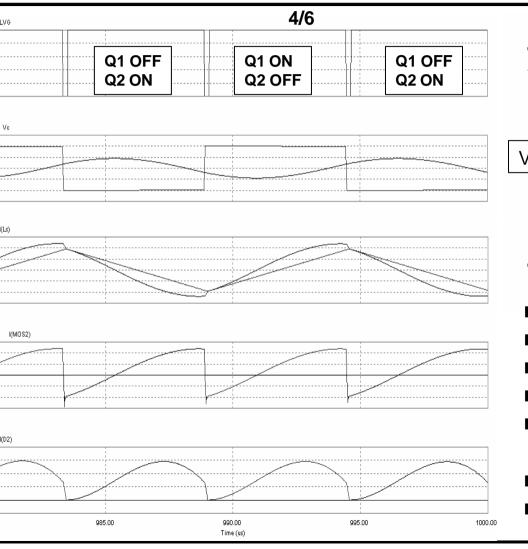


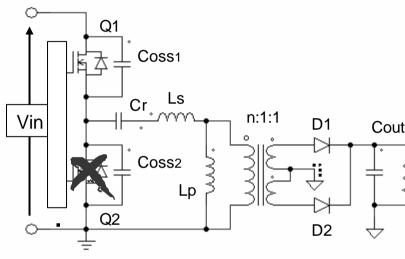
- Q1 and Q2 are OFF (dead-time)
- D1 and D2 are OFF; V(D1)=V(D2)=0; transformer's secondary is open
- I (Ls+Lp) charges C_{OSS2} and discharge C_{OSS1}, until V(C_{OSS2})=Vin; Q1's body of starts conducting, energy goes back
- V(D2) reverses as I (D2) goes to zero
- Phase ends when Q1 is switched on

LC Resonant Half-bridge perating Sequence above resonance (Phase 3/6)



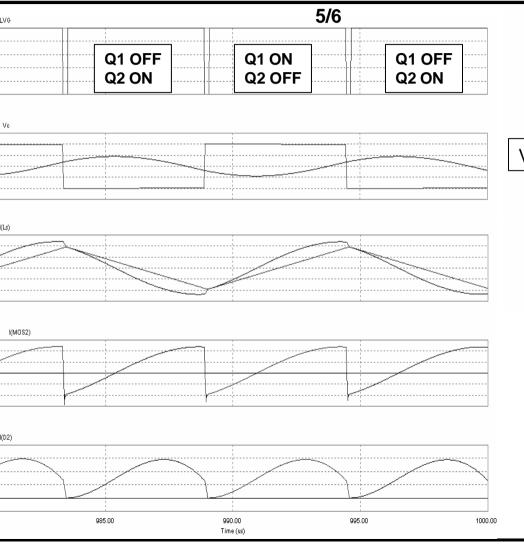
LC Resonant Half-bridge perating Sequence above resonance (Phase 4/6)

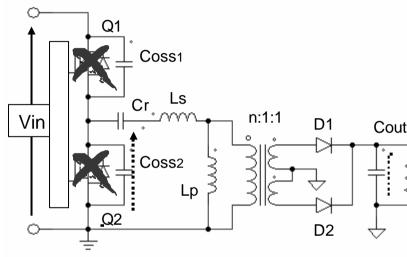




- Q1 is ON, Q2 is OFF
- D1 is ON, D2 is OFF; V(D2)=-2·Vout
- Lp is dynamically shorted: $V(Lp) = n \cdot V$
- Cr resonates with Ls, f_{r1} appears
- I(Ls) flows through Q1's R_{DS(on)} from to ground
- Energy is taken from Vin and goes to
- Phase ends when Q1 is switched off

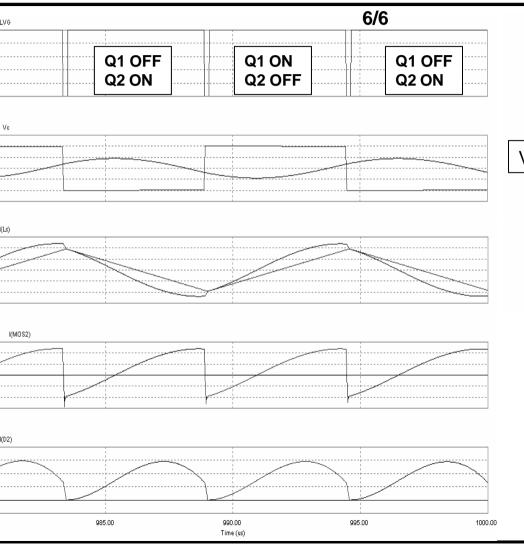
LC Resonant Half-bridge perating Sequence above resonance (Phase 5/6)

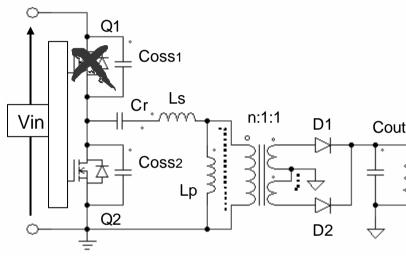




- Q1 and Q2 are OFF (dead-time)
- D1 and D2 are OFF; V(D1)=VD(2)=0; transformer's secondary is open
- I (Ls+Lp) charges C_{OSS1} and discharge C_{OSS2}, until V(C_{OSS2})=0; Q2's body die starts conducting
- Output energy comes from Cout
- Phase ends when Q2 is switched on

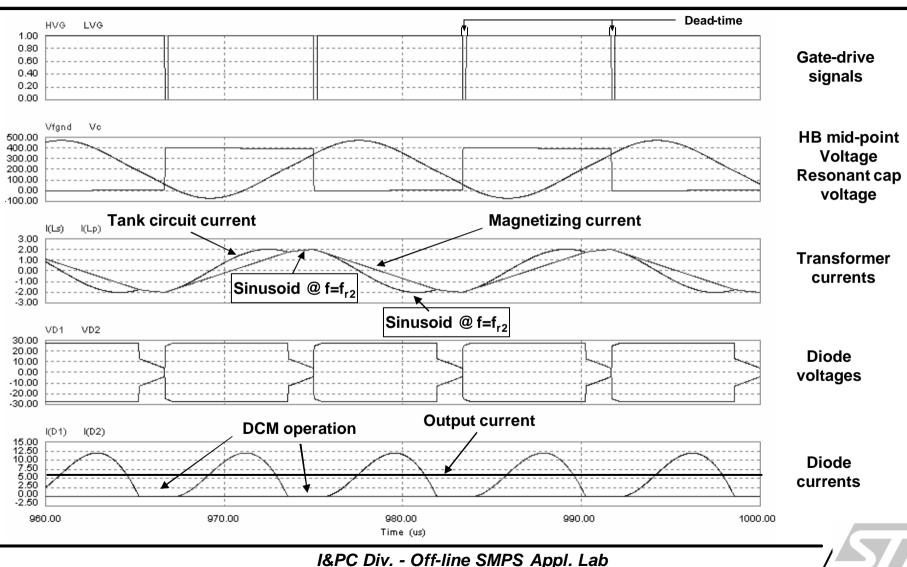
LC Resonant Half-bridge perating Sequence above resonance (Phase 6/6)



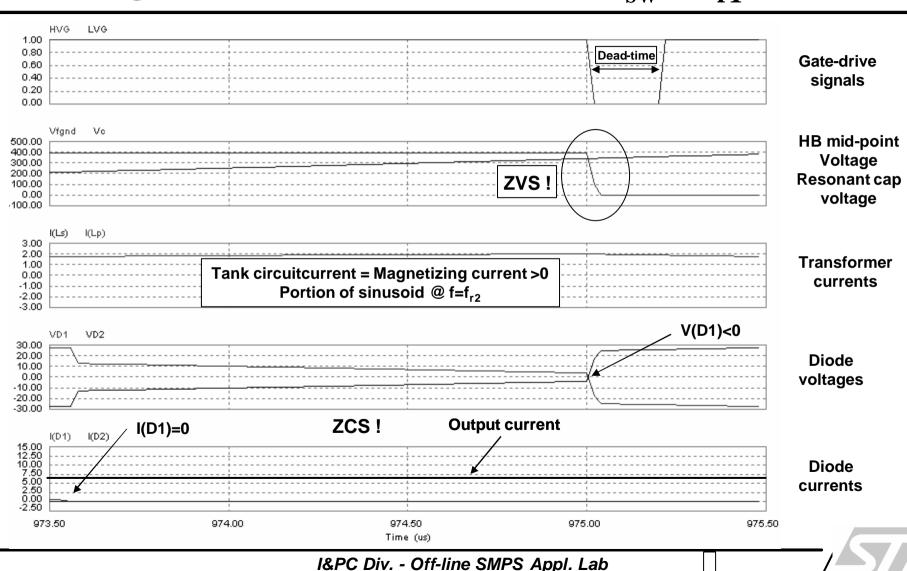


- Q1 is OFF, Q2 is ON
- D1 is OFF, D2 is ON
- Lp is dynamically shorted: V(Lp) =-n·\
- Cr resonates with Ls, fr1 appears
- I(Ls) flows through Q2's R_{DS(on)} (Q2 working in the 3rd quadrant)
- Output energy comes from Cr and Ls
- Phase ends when I (Ls)=0, Phase 1 sta

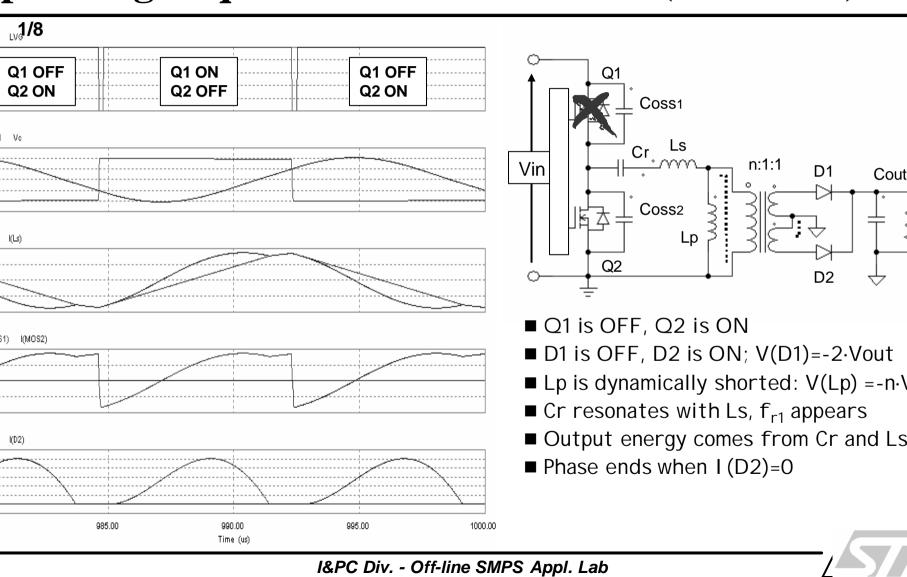
LC Resonant Half-bridge vaveforms below resonance (f_{sw} < f_{r1})



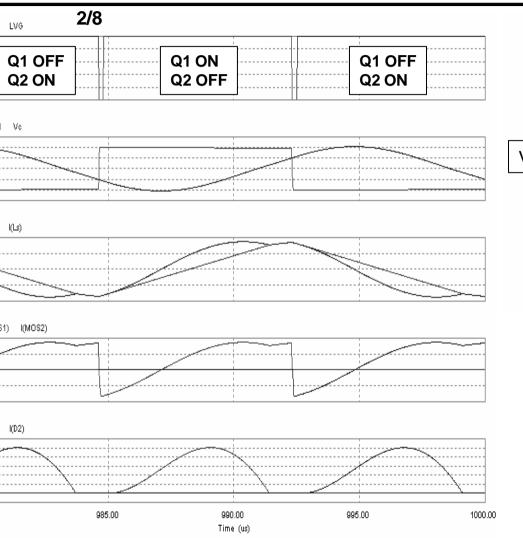
LC Resonant Half-bridge witching details below resonance (f_{sw} < f_{r1})

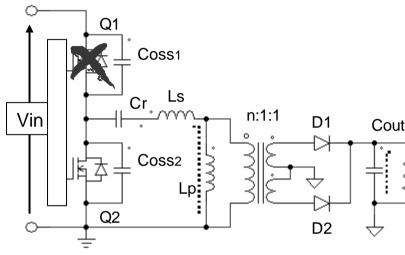


LC Resonant Half-bridge perating Sequence below resonance (Phase 1/8)



LC Resonant Half-bridge perating Sequence below resonance (Phase 2/8)

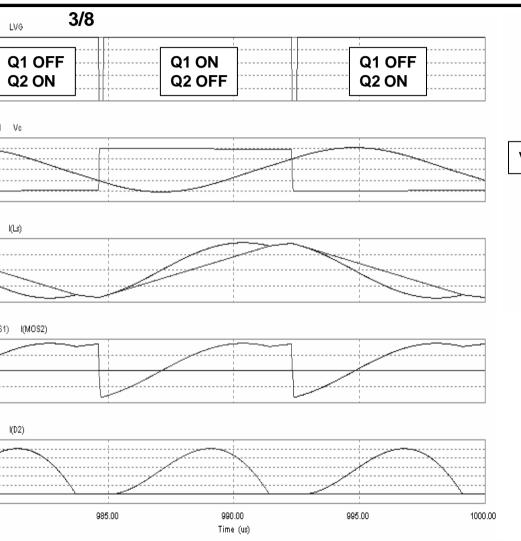


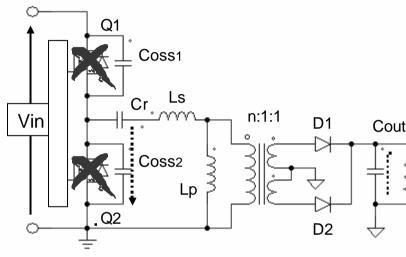


- Q2 is ON, Q1 is OFF
- D1 and D2 are OFF; V(D1)=V(D2)=0; transformer's secondary is open
- Cr resonates with Ls+Lp, f_{r2} appears
- Output energy comes from Cout
- Phase ends when Q2 is switched off



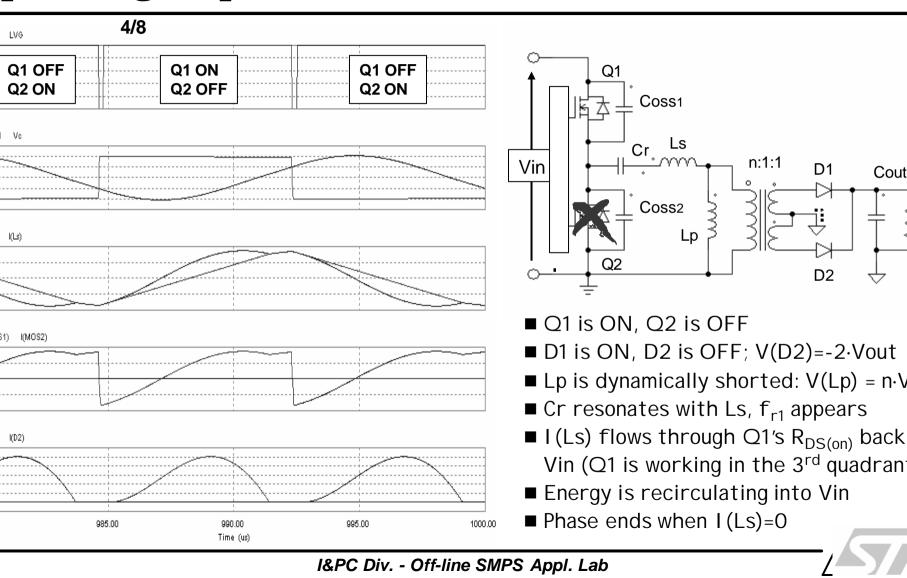
LC Resonant Half-bridge perating Sequence below resonance (Phase 3/8)



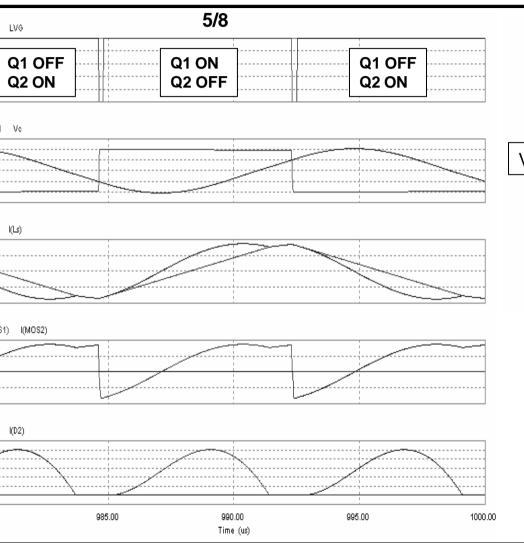


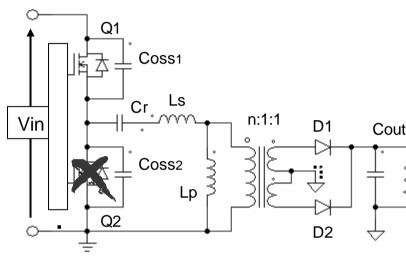
- Q1 and Q2 are OFF (dead-time)
- D1 and D2 are OFF; V(D1)=V(D2)=0; transformer's secondary is open
- I (Ls+Lp) charges C_{OSS2} and discharge C_{OSS1}, until V(C_{OSS2})=Vin; Q1's body of starts conducting, energy goes back
- Phase ends when Q1 is switched on

LC Resonant Half-bridge perating Sequence below resonance (Phase 4/8)



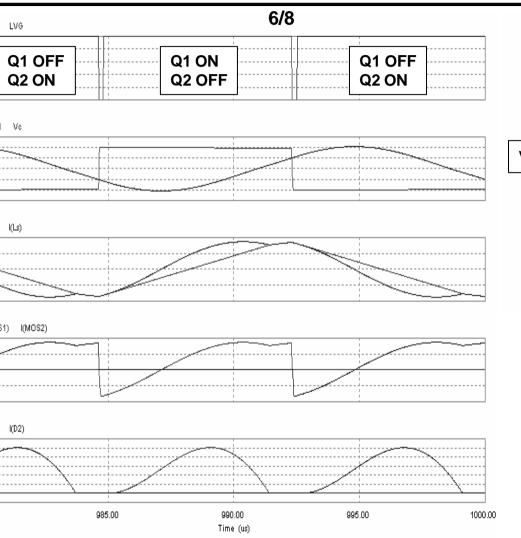
LC Resonant Half-bridge perating Sequence below resonance (Phase 5/8)

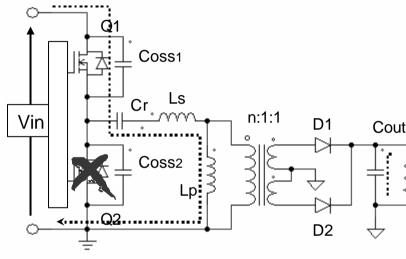




- Q1 is ON, Q2 is OFF
- D1 is ON, D2 is OFF; V(D2)=-2·Vout
- Lp is dynamically shorted: V(Lp) = n·V
- Cr resonates with Ls, f_{r1} appears
- I (Ls) flows through Q1's R_{DS(on)} from to ground
- Energy is taken from Vin and goes to
- Phase ends when I (D1)=0

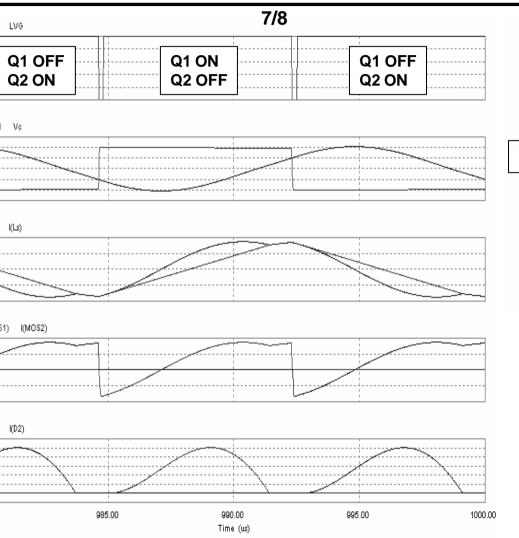
LC Resonant Half-bridge perating Sequence below resonance (Phase 6/8)

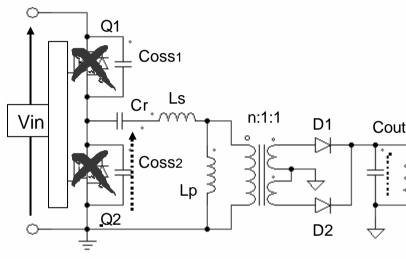




- Q1 is ON, Q2 is OFF
- D1 and D2 are OFF; V(D1)=V(D2)=0; transformer's secondary is open
- Cr resonates with Ls+Lp, f_{r2} appears
- Output energy comes from Cout
- Phase ends when Q1 is switched off

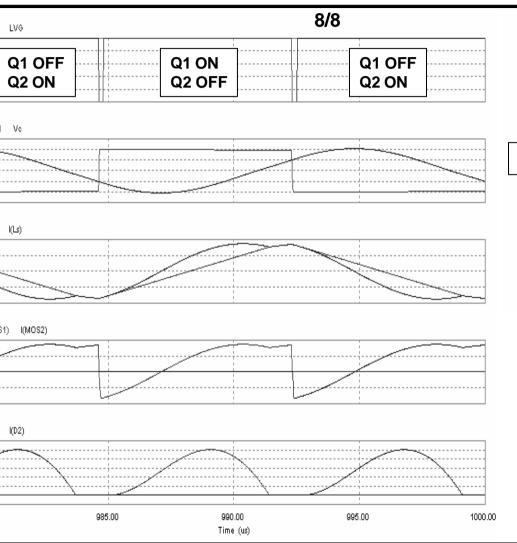
LC Resonant Half-bridge perating Sequence below resonance (Phase 7/8)

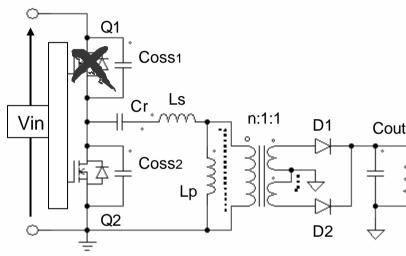




- Q1 and Q2 are OFF (dead-time)
- D1 and D2 are OFF; V(D1)=VD(2)=0; transformer's secondary is open
- I (Ls+Lp) charges C_{OSS1} and discharge C_{OSS2}, until V(C_{OSS2})=0, then Q2's bo diode starts conducting
- Output energy comes from Cout
- Phase ends when Q2 is switched on

LC Resonant Half-bridge perating Sequence below resonance (Phase 8/8)





- Q1 is OFF, Q2 is ON
- D1 is OFF, D2 is ON
- Lp is dynamically shorted: V(Lp) =-n·\
- Cr resonates with Ls, fr1 appears
- I(Ls) flows through Q2's R_{DS(on)} (Q2 working in the 3rd quadrant)
- Output energy comes from Cr and Ls
- Phase ends when I (Ls)=0, Phase 1 sta

LC Resonant Half-bridge apacitive mode ($f_{sw} \sim f_{r2}$): why it must be avoided

Capacitive mode is encountered when f_{sw} gets close to f_{r2} Although in capacitive mode ZCS can be achieved, however ZVS is lost, which causes: Hard switching of Q1 & Q2: high switching losses at turn-on and very high capacitive osses at turn-off Body diode of Q1 & Q2 is reverse-recovered: high current spikes at turn-on, additional

ower dissipation; MOSFETs will easily blow up. High level of generated EMI

Large and energetic negative voltage spikes in the HB midpoint that may cause the

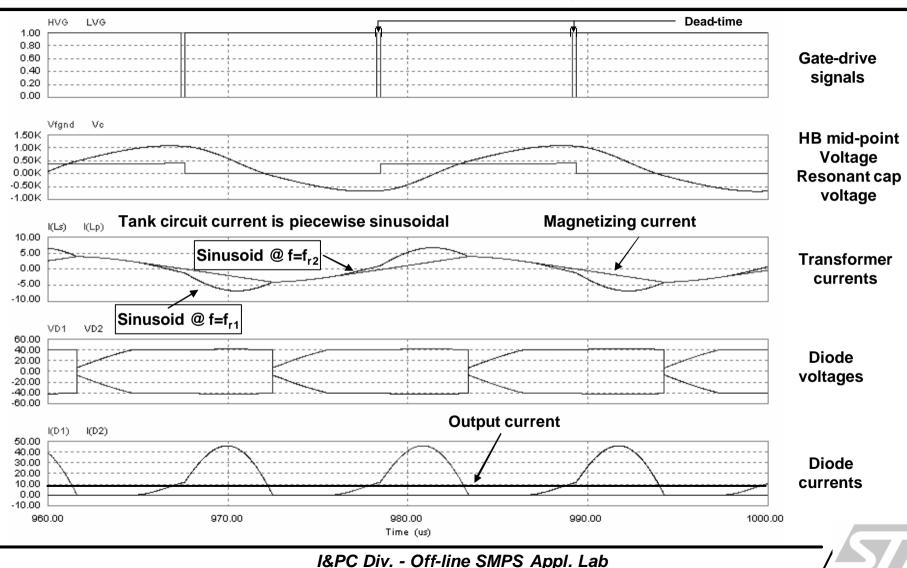
control IC to fail

In consolitive mode the energy ve frequency relationship is reversed

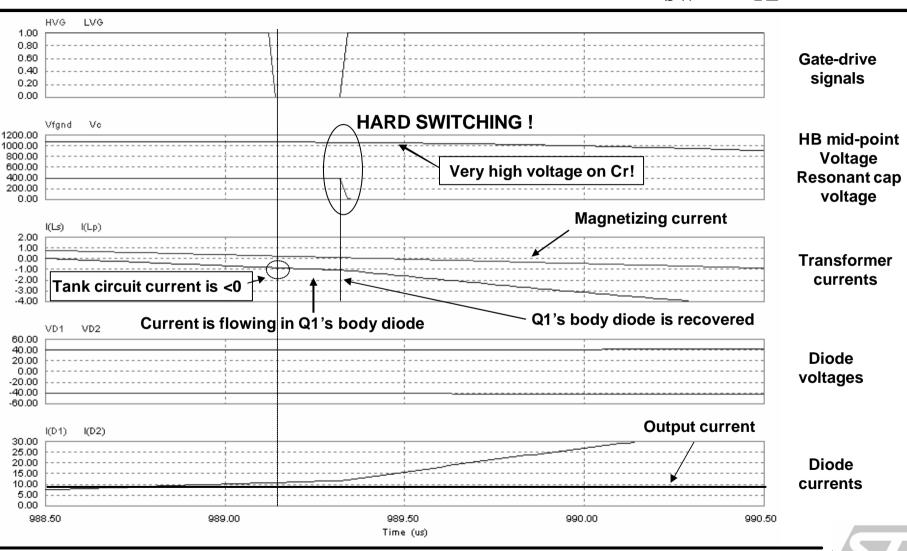
dditionally, feedback loop sign could change from negative to positive:

In capacitive mode the energy vs. frequency relationship is reversed Converter operating frequency would run away towards its minimum (if MOSFETs have not blown up already!)

LC Resonant Half-bridge value of the second second value of value of the second second



LC Resonant Half-bridge witching details in capacitive mode (f_{sw} ~ f_{r2})



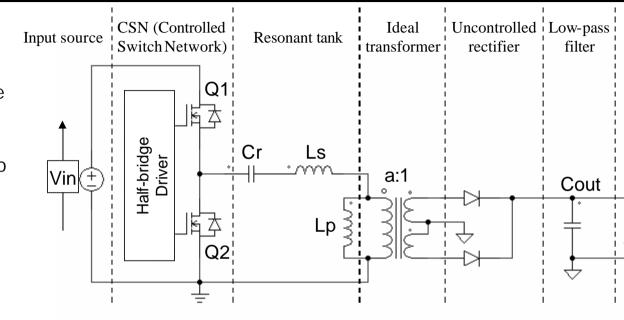
LC Resonant Half-bridge pproximate analysis with FHA approach: Basics

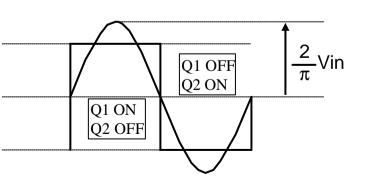
BASIC PRINCIPLES

N provides a square wave voltage a frequency fsw, dead times are glected sonant tank responds primarily to fundamental component, then: nk waveforms are approximated their fundamental components

controlled rectifier + low-pass ter's effect is incorporated into

e load.





Note:

- Cr is both resonant and dc blocking capacitor
- Its ac voltage is superimposed on a dc component equal to Vin/2 (duty cyle is 50% for both Q1 and Q2)



LC Resonant Half-bridge quivalent model with FHA approach

e actual circuit turns into an equivalent ear circuit where the ac resonant tank is sited by an effective sinusoidal input rce and drives an effective resistive load. Indard ac analysis can be used to solve the cuit actions of interest: Input Impedance $(j\omega)$ and Forward Transfer Function $M(j\omega)$.

s possible to show that the complete

version ratio Vout/Vin is: $v_S = \frac{2}{\pi} Vin \cdot \sin(2\pi \cdot fs \cdot t) \qquad \qquad Re = \frac{8}{\pi^2} a$ $\frac{Vout}{Vin} = \| M(j\omega) \|$ $I_{in} = \frac{2}{\pi} \| i_s \| \cos(\varphi_S) = \frac{2}{\pi} \| v_S \| Re \left(\frac{1}{Z_i}\right) \qquad \qquad Iout = \frac{2}{\pi} a$

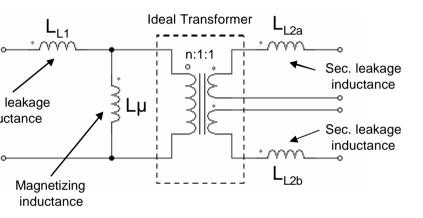
 $\begin{array}{c} \text{controlled} \\ \text{switch} \\ \text{dc input} \\ \text{dc input} \\ \text{i}_{S} \\ \text{Vin} \\ \end{array} \begin{array}{c} \text{i}_{R} \\ \text{v}_{R} \\ \text{Re} \\ \end{array} \begin{array}{c} \text{i}_{Out} \\ \text{low-pass filter} \\ \text{dc o} \\ \text{out} \\ \text{low-pass filter} \\ \text{dc o} \\ \text{low-pass filter} \\ \text{dc o} \\ \text{low-pass filter} \\ \text{dc o} \\ \text{low-pass filter} \\ \text{low-pas$

is result is valid for any resonant topology



LC Resonant Half-bridge ransformer model (I)

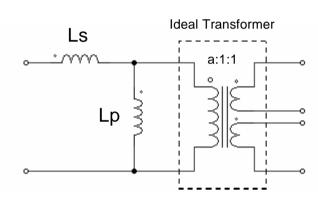
Physical model



the actual primary-to-secondary turn ratio nodels the magnetizing flux linking all windings models the primary flux not linked to secondary and L_{L2b} model the secondary flux not linked to nary; symmetrical windings: $L_{L2a} = L_{L2b}$

ults from the analysis of the magnetic

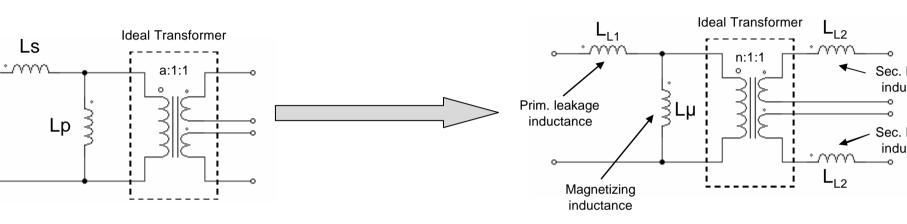
All-Primary-Side equivalent model used for LLC analysis



- APS equivalent model: terminal equations are same, internal parameters are different
- a is <u>not</u> the actual primary-to-secondary turn
- Ls is the primary inductance measured with a secondaries shorted out
- Lp is the difference between the primary inductance measured with secondaries open a

NOTE: $L_{L1} + L\mu = Ls + Lp = L1$ primary winding inductance

LC Resonant Half-bridge ransformer model (II)



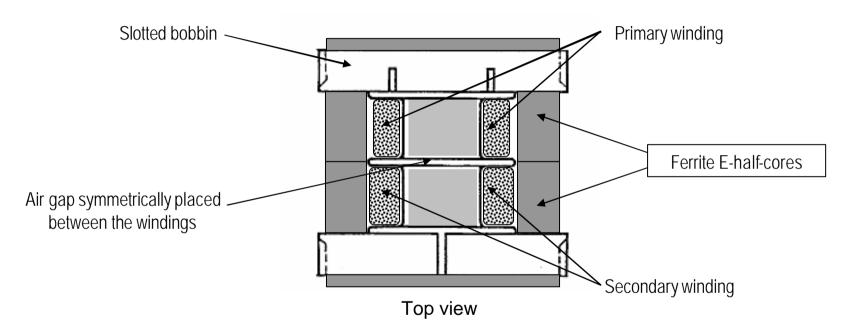
- We need to go from the APS model to the physical model to determine transformer specification
- Undetermined problem (4 unknowns, 3 conditions); one more condition needed (related to the physical magnetic structure)
- Only n is really missing: $L1 = Ls + Lp = L_{L1} + L\mu$ is known and measurable, Ls is measurable
- Magnetic circuit symmetry will be assumed: equal leakage flux linkage for both primary and secondary $\Rightarrow L_{L1} = n^2 \cdot L_{L2}$; then:

$$n = a\sqrt{\frac{Lp}{Lp + Ls}}$$



LC Resonant Half-bridge ransformer model (III)

ample of magnetically symmetrical structure



- Like in any ferrite core it is possible to define a specific inductance A_i (which depends on air gap thickness) such that $L1 = Np^2 \cdot A_i$
- In this structure it is also possible to define a specific leakage inductance A_{LIk} such that Ls=Np²·A_{LIk}. A_{LIk} is a function of bobbin's geometry; it depends on air gap position but not on its thickness

LC Resonant Half-bridge umerical results of ac analysis

The ac analysis of the resonant tank leads to the following result:

■ Input Impedance:

$$Z_{in}(x,k,Q) = Z_{R} \cdot \left[Q \cdot \frac{x^{2} \cdot k^{2}}{1 + x^{2} \cdot k^{2} \cdot Q^{2}} + j \cdot \left(x - \frac{1}{x} + \frac{x \cdot k}{1 + x^{2} \cdot k^{2} \cdot Q^{2}} \right) \right]$$

■ Module of the Forward transfer function (voltage conversion ratio):

$$|M(x,k,Q)| = \frac{1}{2} \cdot \frac{1}{\sqrt{\left[1 + \frac{1}{k} \cdot \left(1 - \frac{1}{x}\right)\right]^2 + Q^2 \cdot \left(x - \frac{1}{x}\right)^2}}$$

where:

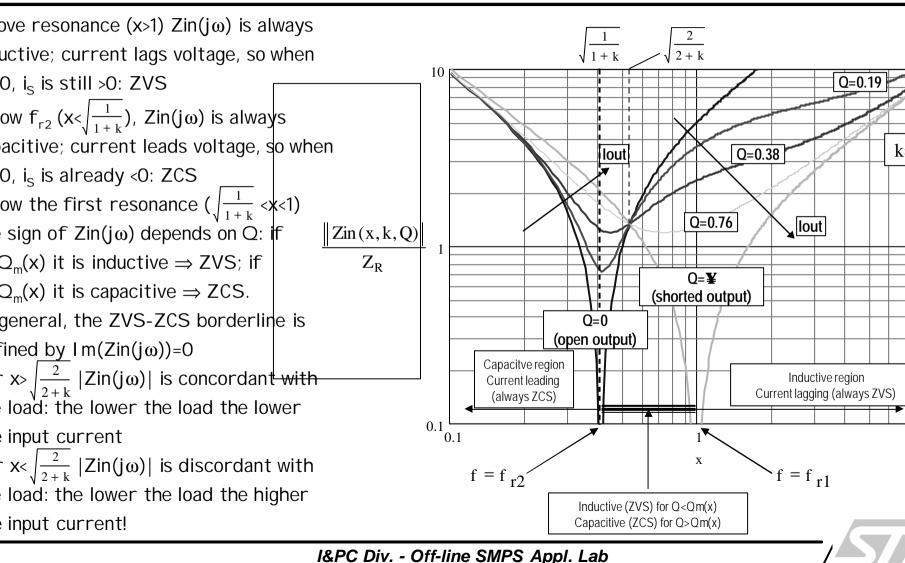
$$f_{r1} = \frac{1}{2 \cdot \pi \cdot \sqrt{Ls \cdot Cr}}; x = \frac{f}{f_{r1}}; k = \frac{Lp}{Ls}; Z_R = \sqrt{\frac{Ls}{Cr}}; Re = \frac{8}{\pi^2} \cdot a^2 \cdot R; Q = \frac{Z_R}{Re}$$

NOTES:

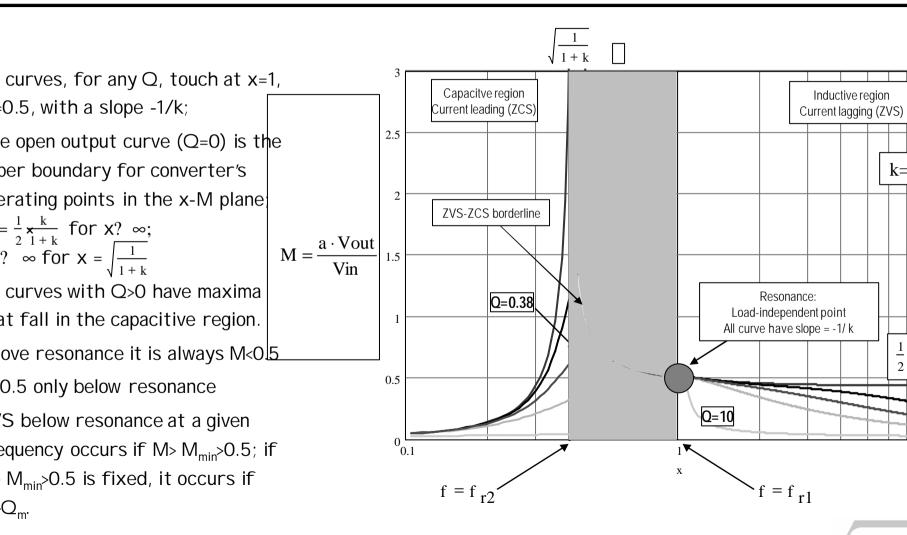
- x is the "normalized frequency"; x<1 is "below resonance", x>1 is "above resonance"
- \blacksquare Z_R is the characteristic impedance of the tank circuit;
- Q, the quality factor, is related to load: Q=0 means Re=∞ (open load), Q=∞ means Re=0 (short circuit); one can think of Q as proportional to I out

LC Resonant Half-bridge

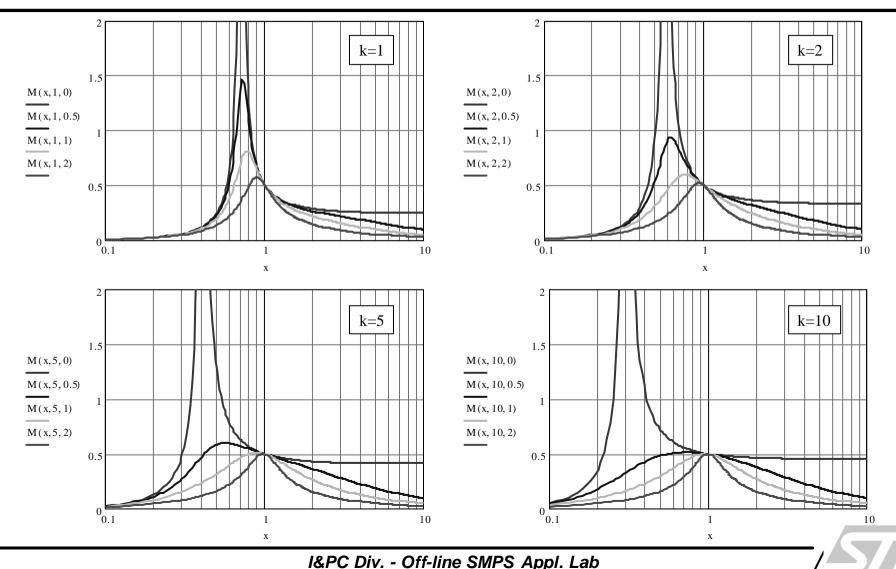
esonant Tank Input Impedance Zin(jw)



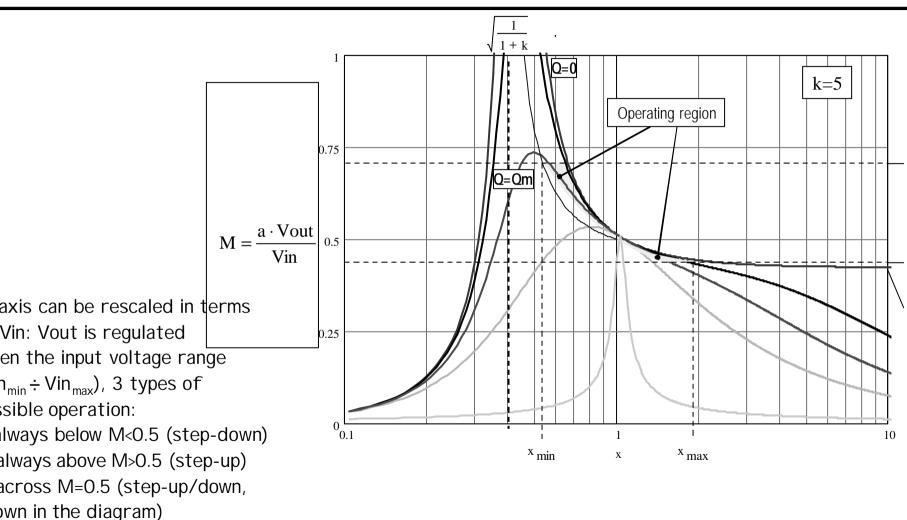
LC Resonant Half-bridge oltage conversion ratio ||M(j**w**)||



LC Resonant Half-bridge ffect of k on ||M(jw)||



LC Resonant Half-bridge perating region on ||M(jw)|| diagrams



LC Resonant Half-bridge ull-load issue: ZVS at min. input voltage

Zin(jω) analysis has shown that ZVS occurs for x<1, provided Q≤Q_m, i.e. Im[Zin(jω)] ≥ 0.
f Q=Q_m (Im[Zin(jω)] = 0) the switched current is exactly zero, This is only a necessary condition for ZV

not sufficient because the parasitic capacitance of the HB midpoint, neglected in the FHA approach, nee

ome energy (i.e. current) to be fully charged or depleted within the dead-time (i = C dv/dt)

A minimum current must be switched to make sure that the HB midpoint can swing rail-to-rail within the lead-time. Then, it must be $Q \le Q_7 < Q_m$.

Mathematically, the ZVS condition is:

$$\frac{\operatorname{Im}(\left(Z_{\operatorname{in}}(x,k,Q)\right)}{\operatorname{Re}(\left(Z_{\operatorname{in}}(x,k,Q)\right)} \ge \frac{2 \cdot \operatorname{Coss} + \operatorname{C}_{\operatorname{stray}}}{\pi \cdot \operatorname{Td}} \cdot \frac{\operatorname{Vin}_{\min}^{2}}{\operatorname{Pin}_{\max}}$$

Coss is the MOSFET's output capacitance, Cstray an additional contribution due to transformer's winding and the layout

Analytic expression of Q_Z is not handy; a good rule of thumb is to consider the value of Q_m and take 10% nargin for component tolerance: FHA gives conservative results as far as the ZVS condition is concerned

LC Resonant Half-bridge o-load issues: regulation

C converter can regulate down to zero load, ike the conventional LC series-resonant a frequency $\gg f_{r1}$ Cr disappears and the output tage is given by the inductive divider made up Ls and Lp

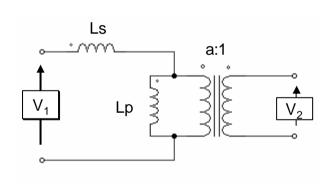
the minimum voltage conversion ratio is greater an the inductive divider ratio, regulation will be ssible at some finite frequency is links the equivalent turn ratio a and the

$$a \cdot \frac{\text{Vout}}{\text{Vin}_{\text{max}}} > \frac{1}{2} \cdot \frac{k}{1+k}$$

luctance ratio k:

is is equivalent to the graphical constraint that e horizontal line a Vout/Vin_{max} must cross the curve

Equivalent schematic of LLC converter for \mathbf{x} ?



$$V_2 = V_1 \cdot \frac{1}{a} \cdot \frac{Lp}{Ls + Lp}$$



LC Resonant Half-bridge o-load issues: ZVS

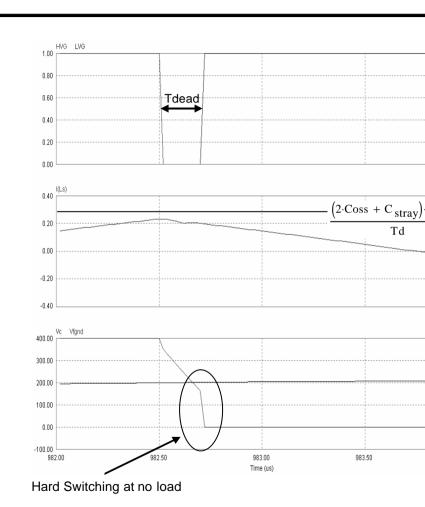
 $n(j\omega)$ analysis has shown that ZVS always occurs x>1, even at no load (Q=0)

1 is actually only a necessary condition for ZVS,

t sufficient because of the parasitic capacitance the HB midpoint neglected in the FHA approach minimum current must be ensured at no load to the HB midpoint swing rail-to-rail within the ad-time.

is poses an additional constraint on the maximum lue of Q at full load:

$$Q \le \frac{\pi}{4} \cdot \frac{1}{(1+k) \cdot x_{\text{max}}} \cdot \frac{\text{Td}}{\text{Re} \cdot \left(2 \cdot \text{Coss} + C_{\text{stray}}\right)}$$



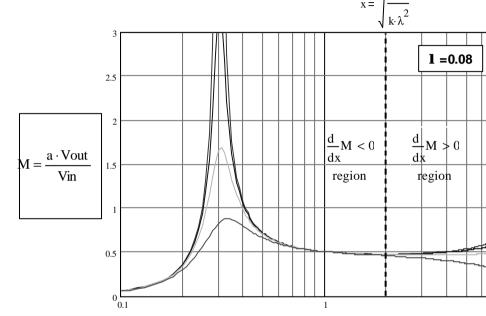


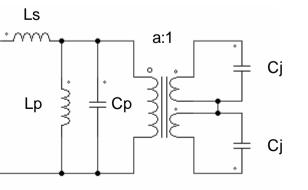
LC Resonant Half-bridge o-load issues: Feedback inversion

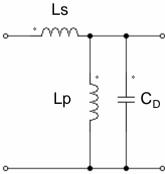
Parasitic intrawinding and interwinding capacitance are summarized in Cp Cj is the junction capacitance of the output rectifiers; each contributes for half cycle Under no-load, rectifiers have low reverse voltage applied, Cj increases.

The parasitic tank has a high-frequency resonance that makes M increase at some point: feedback becomes positive, system oses control

Cure: minimize Cp and Cj, limit max fsw.







$$C_D = Cp + \frac{C_j}{a^2}$$
 $\lambda = \sqrt{\frac{C_D}{Cr}}$

LC Resonant Half-bridge esign procedure. General criteria.

DESIGN SPECIFICATION

- Vin range, holdup included (Vin_{min} ÷ Vin_{max})
- Nominal input voltage (Vin_{nom})
- Regulated Output Voltage (Vout)
- Maximum Output Power (Pout_{max})
- Resonance frequency: (f_r)
- Maximum operating frequency (f_{max})

ADDITIONAL INFO

- \blacksquare C_{oss} and C_{stray} estimate
- Minimum dead-time

- The converter will be designed to work at resonance at nominal Vin
- Step-up capability (i.e. operation below resonance) will be used to handle holdup
- The converter must be able to regulate down to zero load at max. Vin
- Q will be chosen so that the converter will always work in ZVS, from zero load to Pout_{max}

■ There are many degrees of freedom, then many design procedures are possible. We will choose one of the simplest ones



LC Resonant Half-bridge esign procedure. Proposed algorithm (I).

1. Calculate min., max. and nominal conversion ratio with a=1:

$$M_{min} = \frac{Vout}{Vin_{max}}$$
 $M_{max} = \frac{Vout}{Vin_{min}}$ $M_{nom} = \frac{Vout}{Vin_{nom}}$

2. Calculate the max. normalized frequency x_{max} :

$$x_{\text{max}} = \frac{f_{\text{max}}}{f_{\text{r}}}$$

3. Calculate a so that the converter will work at resonance at nominal voltage

$$a = \frac{1}{2 \cdot M_{\text{nom}}}$$

4. Calculate k so that the converter will work at x_{max} at zero load and max. input voltage:

$$k = \frac{2 \cdot a \cdot M_{min}}{1 - 2 \cdot a \cdot M_{min}} \cdot \left(1 - \frac{1}{x_{max}}\right)$$

5. Calculate the max. Q value, Q_{max1} , to stay in the ZVS region at min. Vin and max. load:

$$Q_{\text{max}1} = \frac{1}{k} \cdot \frac{1}{2 \cdot a \cdot M_{\text{max}}} \cdot \sqrt{\frac{\left(2 \cdot a \cdot M_{\text{max}}\right)^2}{\left(2 \cdot n \cdot M_{\text{max}}\right)^2 - 1} + k}$$

LC Resonant Half-bridge esign procedure. Proposed algorithm (II).

6. Calculate the effective load resistance:

$$Re = \frac{8}{\pi^2} \cdot a^2 \cdot R = \frac{8}{\pi^2} \cdot a^2 \cdot \frac{Vout^2}{Pout_{max}}$$

7. Calculate the max. Q value, Q_{max2} , to ensure ZVS region at zero load and max. Vin:

$$Q_{\text{max2}} = \frac{\pi}{4} \cdot \frac{1}{(1+k) \cdot x_{\text{max}}} \cdot \frac{\text{Td}}{\text{Re} \cdot (2 \cdot \text{Coss} + C_{\text{stray}})}$$

- 8. Choose a value of Q_1 , Q_2 , such that $Q_3 \le \min(Q_{max1}, Q_{max2})$
- Calculate the value x_{min} the converter will work at, at min. input voltage and max. load:

$$x_{min} = \frac{1}{1 + k \cdot \left[1 - \frac{1}{1 + \left(\frac{Q_S}{Q_{max1}}\right)^4}\right]}$$

10. Calculate the characteristic impedance of the tank circuits and all component values:

$$Z_R = \text{Re} \cdot Q_S$$
 $C_S = \frac{1}{2 \cdot \text{fr} \cdot Z_R \cdot \pi}$ $L_S = \frac{Z_R}{2 \cdot \pi \cdot \text{fr}}$ $L_P = k \cdot L_S$

ELECTRICAL SPECIFICATION

Vin range	320 to 450 Vdc	320V after 1 missing cycle; 450 V is the OVP theshold of the PFC pre-regulator
Nominal input voltage	400 Vdc	Nominal output voltage of PFC
Regulated ouput voltage Maximum output Current	24 V 12 A	Total Pout is 300 W
Resonance frequency	90 kHz	
Maximum switching frequency	180 kHz	
Start-up switching frequency	300 kHz	
HB midpoint estimated parasitic capacitance	200 pF	
Minimum dead-time (L6599)	200 ns	

1. Calculate min. and max. and nominal conversion ratio referring to 24V output:

$$M_{min} = \frac{Vout}{Vin_{max}} = \frac{24}{450} = 0.053$$
 $M_{max} = \frac{Vout}{Vin_{min}} = \frac{24}{320} = 0.075$ $M_{nom} = \frac{Vout}{Vin_{nom}} = \frac{24}{400} = 0.06$

2. Calculate the max. normalized frequency x_{max} :

$$x_{\text{max}} = \frac{f_{\text{max}}}{f_{\text{r}}} = \frac{180}{90} = 2$$

3. Calculate a so that the converter will work at resonance at nominal voltage

$$a = \frac{1}{2 \cdot M_{pom}} = \frac{1}{2 \cdot 0.06} = 8.333$$

4. Calculate k so that the converter will work at x_{max} at zero load and max. input voltage:

$$k = \frac{2 \cdot a \cdot M_{min}}{1 - 2 \cdot a \cdot M_{min}} \cdot \left(1 - \frac{1}{x_{max}}\right) = 6$$

5. Calculate the max. Q value, Q_{max1} , to stay in the ZVS region at min. Vin and max. load:

$$Q_{\text{max}1} = \frac{1}{k} \cdot \frac{1}{2 \cdot a \cdot M_{\text{max}}} \cdot \sqrt{\frac{\left(2 \cdot a \cdot M_{\text{max}}\right)^{2}}{\left(2 \cdot n \cdot M_{\text{max}}\right)^{2} - 1}} + k = 0.395$$

6. Calculate the effective load resistance:

Re =
$$\frac{8}{\pi^2} \cdot a^2 \cdot R = \frac{8}{\pi^2} \cdot a^2 \cdot \frac{\text{Vout}^2}{\text{Pout}_{\text{max}}} = 108.067 \quad \Omega$$

7. Calculate the max. Q value, Q_{max2} , to ensure ZVS at zero load:

$$Q_{\text{max2}} = \frac{\pi}{4} \cdot \frac{1}{(1+k) \cdot x_{\text{max}}} \cdot \frac{\text{Td}}{\text{Re} \cdot (2 \cdot \text{Coss} + C_{\text{stray}})} = 0.519$$

- 8. Choose a value of Q, Q_S , such that $Q_S \le min(Q_{max1}, Q_{max2})$ Considering 10% margin: $Q_S = 0.9 \cdot 0.395 = 0.356$
- 9. Calculate the value x_{min} the converter will work at, at min. input voltage and max. load:

$$x_{min} = \sqrt{\frac{1}{1 + k \cdot \left[1 - \frac{1}{1 + \left(\frac{Q_S}{Q_{max1}}\right)^4}\right]}} = 0.592 \qquad f_{min} = 90 \cdot 0.592 = 53.28 \text{ kHz}$$

10. Calculate the characteristic impedance of the tank circuits and all component values:

$$Z_{R} = \text{Re} \cdot Q_{S} = 38.472 \ \Omega$$
 $C_{S} = \frac{1}{2 \cdot \text{fr} \cdot Z_{R} \cdot \pi} = 46 \ \text{nF}$ $L_{S} = \frac{Z_{R}}{2 \cdot \pi \cdot \text{fr}} = 68 \ \mu\text{H}$ $L_{P} = k \cdot L_{S} = 408 \ \mu\text{H}$

- 11. Calculate components around the L6599:
 - Oscillator setting. Choose C_F (e.g. 470 pF as in the datasheet). Calculate RFmin:

$$\mathsf{RF}_{min} = \frac{1}{3 \cdot \mathsf{CF} \cdot \mathsf{f}_{min}} = \frac{1}{3 \cdot 470 \cdot 10^{-12} \cdot 53.28 \cdot 10^{3}} = 13.3 \,\mathsf{k}\Omega$$

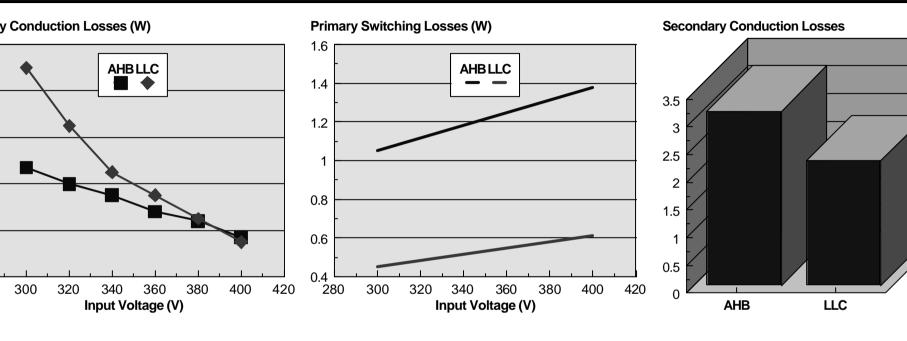
Calculate RFmax:

$$\mathsf{RF}_{max} = \frac{\mathsf{RF}_{min}}{\frac{\mathsf{f}_{max}}{\mathsf{f}_{min}} - 1} = \frac{13.3 \cdot 10^3}{\frac{180}{53.28} - 1} = 5.54 \text{ k}\Omega$$

Calculate Soft-start components:

$$R_{SS} = \frac{RF_{min}}{\frac{f_{start}}{f_{min}}} = \frac{13.3 \cdot 10^{3}}{\frac{300}{53.28} - 1} = 2.87 \text{ k}\Omega \qquad C_{SS} = \frac{3 \cdot 10^{-3}}{R_{SS}} = \frac{3 \cdot 10^{-3}}{2.87 \cdot 10^{-3}} = 1 \,\mu\text{F}$$

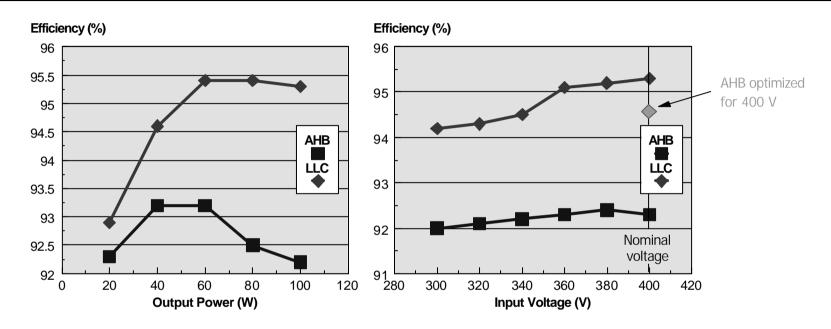
LC Resonant Half-bridge omparison with ZVS Half-bridge (I)



ECTRICAL SPECIF	ICATION		
put Voltage:	300 to 400(*) Vdc		
utput voltage:	20 Vdc		
utput power:	100 W		
witching frequency:	200 kHz		
300 V holdup, 400 V nominal voltage			

	AHB	110
	7	
Primary Conduction Losses	0.97 W	0.95
Primary Switching Losses	1.38 W	0.61
Secondary Conduction Losses	3.15 W	2.25
Secondary Switching Losses	?	O V
Total Losses	5.92 + ? W	3.81

LC Resonant Half-bridge omparison with ZVS Half-bridge (II)



ZVS Half-bridge

- MOSFETs: high turn-off losses; ZVS at light load difficult to achieve
- Diodes: high voltage stress ⇒ higher V_F ⇒ higher conduction losses; recovery losses
- Holdup requirements worsen efficiency at nominal input voltage

LLC resonant half-bridge

- MOSFETs: low turn-off losses; ZVS at light load easy to achieve
- Diodes: low voltage stress (2·Vout) ⇒ lower V_F ⇒ low conduction losses; ZCS ⇒ no recovery losses
- Operation can be optimized at nominal input voltage

